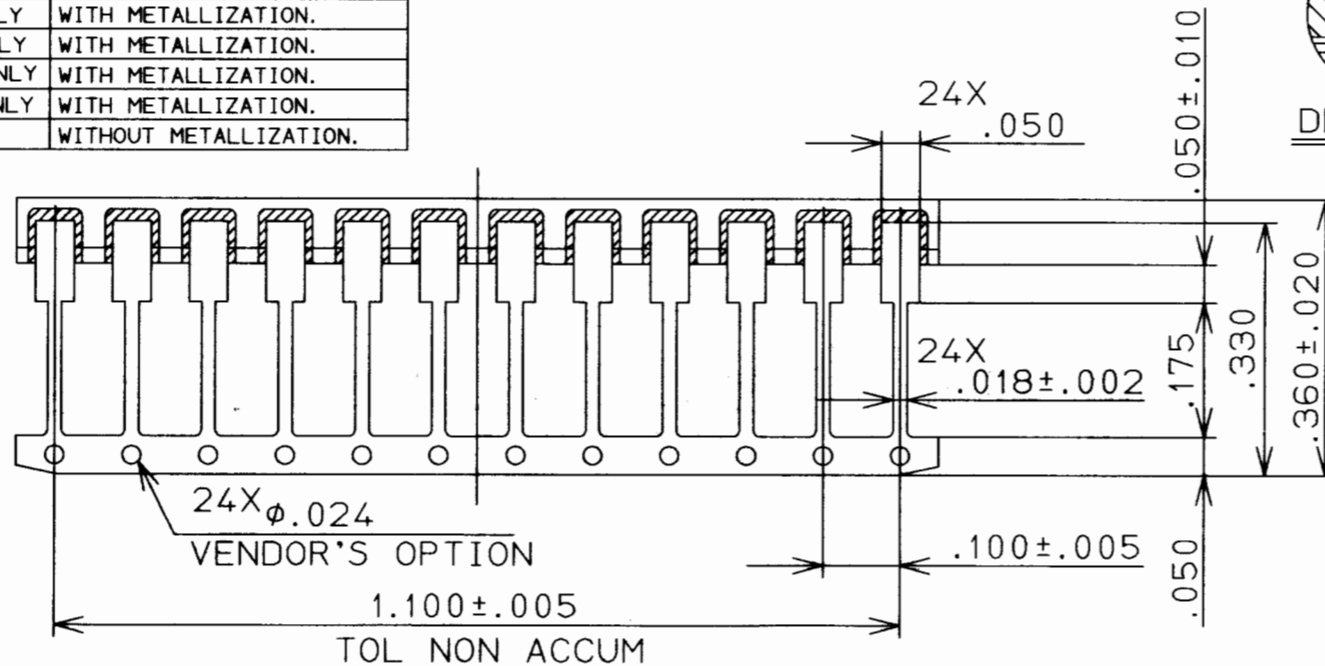


PART NO.	INDEX MARK	LEAD TIED DOWN	NOTCH AREA METALLIZED
01	WITHOUT	NIL	WITH METALLIZATION.
02		NO.1 ONLY	WITH METALLIZATION.
03		NO.9 ONLY	WITH METALLIZATION.
04		NO.12 ONLY	WITH METALLIZATION.
05		NO.24 ONLY	WITH METALLIZATION.
06	WITHOUT	NIL	WITHOUT METALLIZATION.



NOTES:

1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
2. SEAL AREA TO BE METALLIZED.
3. DIE ATTACH AREA TO BE METALLIZED.
4. LEAD RESISTANCE: 0.30 OHM MAX.
5. WIRE BOND PAD CONNECTED TO CORRESPONDING OUTER LEADS.

SB024I382-6	S=0 D=0
SB024I382-5	S=0 D=24
SB024I382-4	S=12 D=12
SB024I382-3	S=9 D=9
SB024I382-2	S=1 D=1
SB024I382-1	S=0 D=0

MODIFICATION						NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
						24 LEAD SIDE BRAZED PACKAGE	UNLESS OTHERWISE SPECIFIED	K.O	K.M		SEP.11.'78
	REDRAWN	MAY.14.'07	Y.H	H.Y/M.SU	H.SA	SCALE 4/1	±.005				
	REDRAWN (CONVERTED CAD DATA)	NOV.21.'93	H.SH	H.SU/S.F	T.A	MATERIAL AS INDICATED	THIRD ANGLE PROJECTION				
	CHANGED	DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO.		SHEET	
								KD-S78382-H		1/2	

